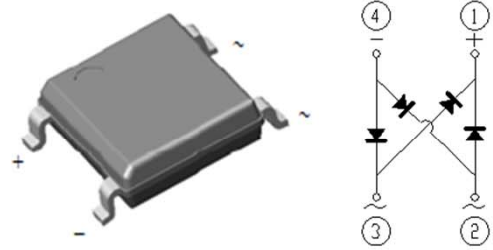


## Features

- Case:ABF
- Glass passivated standard bridge rectifiers
- Ideal for automated placement
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Halogen-free according to IEC 61249-2-21 definition



## Typical Applications

For use of general purpose AC to DC bridge rectification in power supply, charger, office appliance, home appliance and telecom device.

Maximum Ratings (TA = 25 °C unless otherwise noted)								
Parameter	Symbol	LB201S	LB202S	LB204S	LB206S	LB208S	LB2010S	Unit
Maximum repetitive peak reverse voltage	VRRM	100	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	100	200	400	600	800	1000	V
Maximum average output rectified current	Io(AV)	2.0						A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	IFSM	60						A
Rating for fusing(t<8.3ms)	I <sup>2</sup> t	15						A <sup>2</sup> sec
Operating junction and storage temperature range	TJ, TSTG	- 55 to + 150						°C

Electrical Characteristics (TA = 25 °C unless otherwise noted)									
Parameter	Test Conditions	Symbol	LB201S	LB202S	LB204S	LB206S	LB208S	LB2010S	Unit
Maximum instantaneous forward voltage	IF=2.0A TA=25°C	V <sub>F</sub>	1.1						Volts
Maximum DC reverse current at rated DC blocking voltage	TA=25°C TA=125°C	I <sub>R</sub>	5.0 100						µA
Typical junction capacitance	4.0 V, 1 MHz	C <sub>J</sub>	10						pF

Thermal Characteristics								
Parameter	Symbol	LB201S	LB202S	LB204S	LB206S	LB208S	LB2010S	Unit
Typical thermal resistance <sup>(1)</sup>	R <sub>θJA</sub>	80						°C/W
	R <sub>θJL</sub>	25						

Notes: 1. Mounted on FR-4 P.C.B Board



**Ratings and Characteristics Curves**

(TA = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

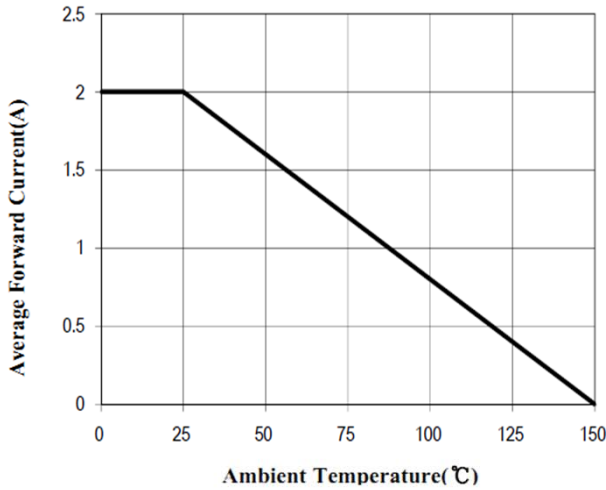


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

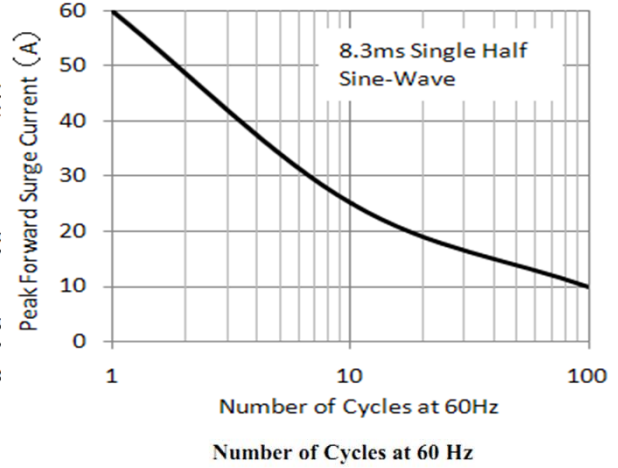


Fig.3 Typical Instantaneous Forward Characteristics

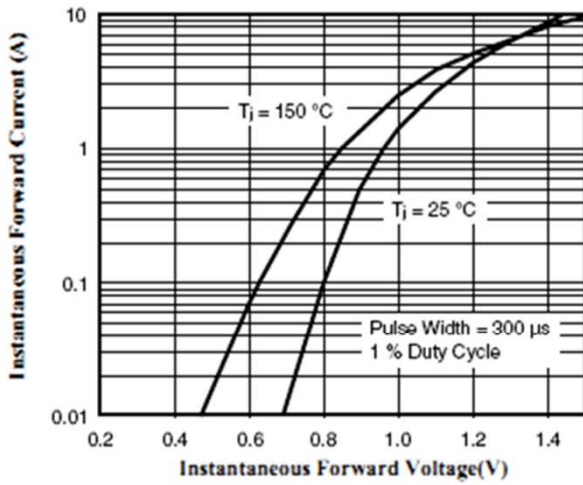


Fig.4 Forward Power Dissipation

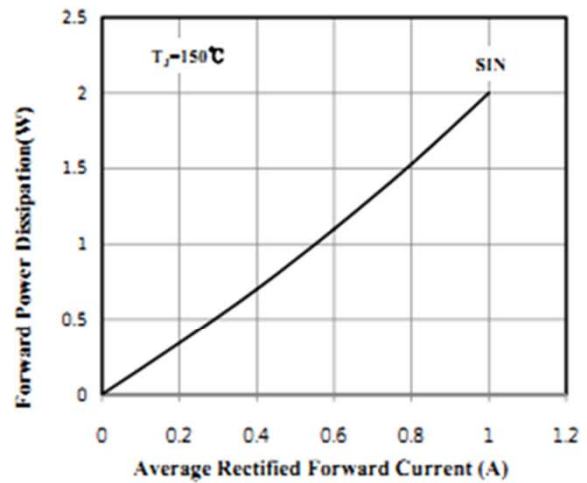
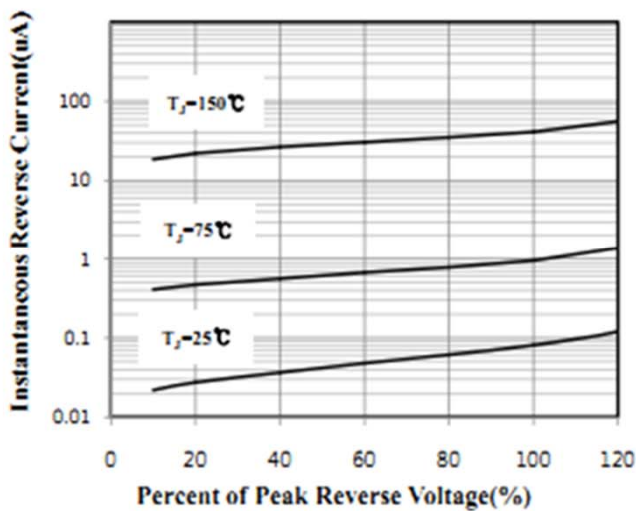
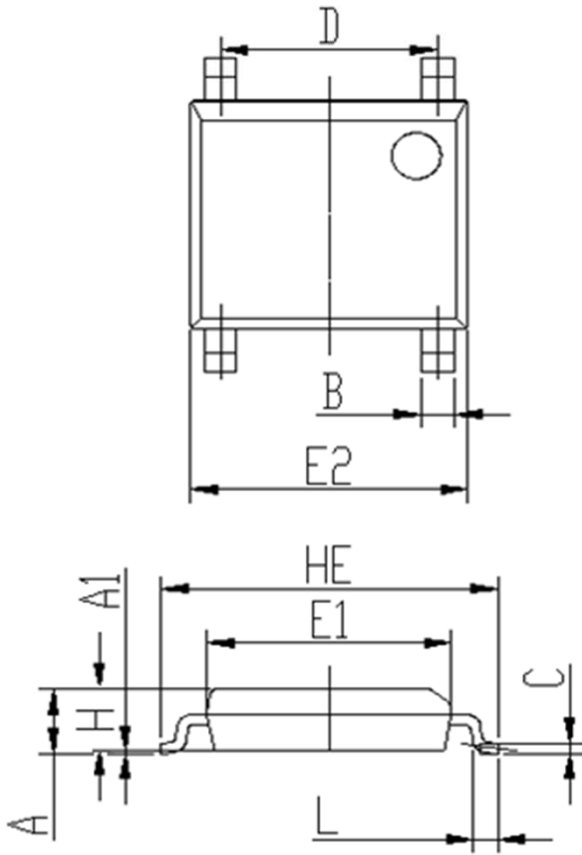


Fig.5 Typical Reverse Characteristics

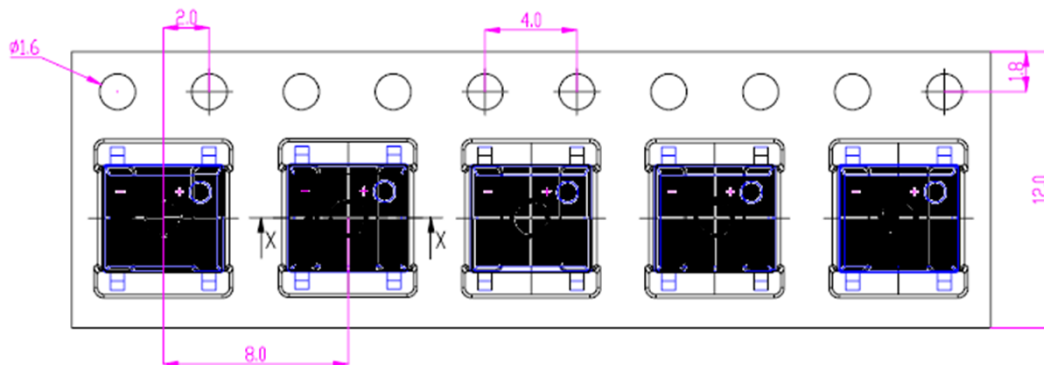


## Package Outline Dimensions

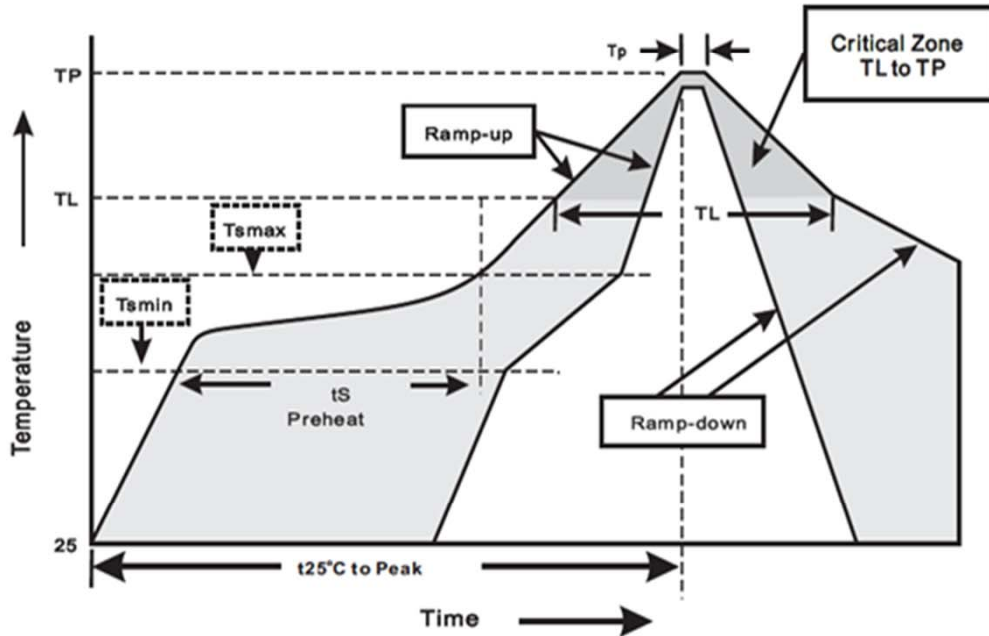


DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	1.25	1.35	0.049	0.053
A1	0.00	0.15	0.000	0.006
B	0.50	0.70	0.020	0.028
C	0.15	0.30	0.006	0.012
D	3.80	4.20	0.150	0.165
E1	4.40	4.60	0.173	0.181
E2	5.00	5.20	0.197	0.205
L	0.25	0.65	0.010	0.026
HE	6.00	6.40	0.236	0.252
H	1.20	1.30	0.047	0.051

## TAPING ORIENTATION



## Soldering Parameters



Reflow Soldering		Sn-Pb Eutectic Assembly	Pb-Free assembly
Pre Heat	- Temperature Min (Ts(min))	100°C	150°C
	- Temperature Max (Ts(max))	150°C	200°C
	- Time (min to max) (ts)	60 – 120 secs	60 – 180 secs
Average ramp up rate (Liquidus Temp (TL) to peak)		3°C/second max	3°C/second max
TS(max) to TL - Ramp-up Rate		3°C/second max	3°C/second max
Reflow	- Temperature (TL) (Liquidus)	183°C	217°C
	- Time (min to max) (ts)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (TP)		240+0/-5 °C	240+0/-5°C
Time within 5°C of actual peak Temperature (tp)		10 – 30 seconds	20 – 40 seconds
Ramp-down Rate		6°C/second max	6°C/second max
Time 25°C to peak Temperature (TP)		6 minutes Max.	8 minutes Max.
Do not exceed		260°C	260°C

Wave Soldering	
Peak Temperature :	260+0/-5°C
Dipping Time :	10 seconds
Soldering :	1 time



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